

### Part Number: XZURMG98W

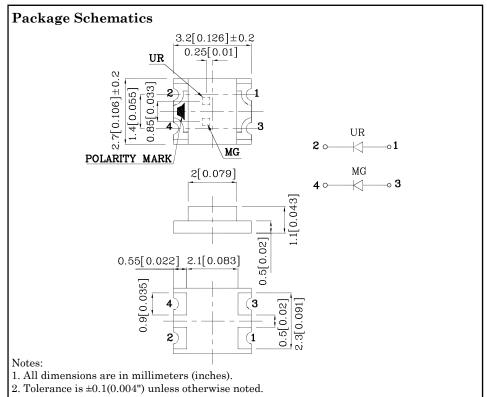
3.2x2.7mm SURFACE MOUNT LED LAMP

### **Features**

- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- ullet Package : 2000 pcs / reel
- $\bullet$  Moisture sensitivity level : level 3
- RoHS compliant







3. Specifications are subject to change without notice.

Absolute Maximum Ratings ( $T_A=25^{\circ}\mathrm{C}$ )		UR (GaAsP/ GaP) MG (GaP)		Unit
Reverse Voltage	$V_{\rm R}$	5	5	V
Forward Current	$I_{\mathrm{F}}$	30	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	160	140	mA
Power Dissipation	$P_{D}$	75	62.5	mW
Operating Temperature	$T_{\rm A}$	-40 ~ +85		°C
Storage Temperature	Tstg	-40 ~ +85		

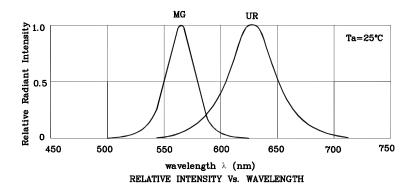
Operating Characteristics (T <sub>A</sub> =25°C)		UR (GaAsP/ GaP)	MG (GaP)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2	2.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	2.5	V
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_{ m R}$	10	10	uA
Wavelength of Peak Emission (Typ.) (I <sub>F</sub> =20mA)	λP	627	565	nm
Wavelength of Dominant Emission (Typ.) $(I_F=20\text{mA})$	λD	625	568	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	Δλ	45	30	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	15	15	pF

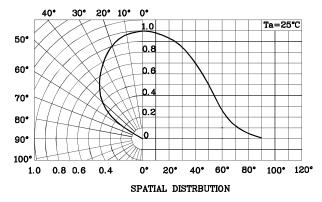
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (I <sub>F</sub> =20mA) mcd		Wavelength $nm \ \lambda P$	Viewing Angle 20 1/2
				min.	typ.		
XZURMG98W —	Red	GaAsP/GaP	Water Clear -	10	17	627	100°
	Green	GaP		10	17	565	

Apr 13,2011 XDSA5773 V4 Layout: Maggie L.

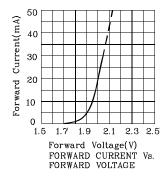


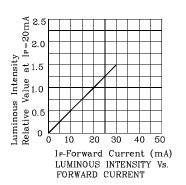


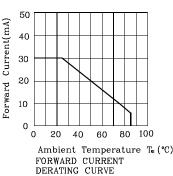


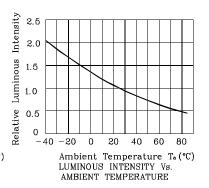


### ❖ UR

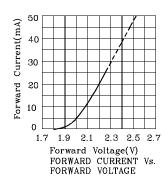


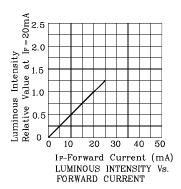


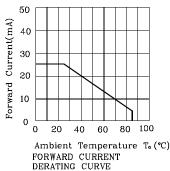


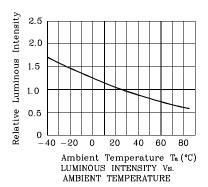


### **♦** MG







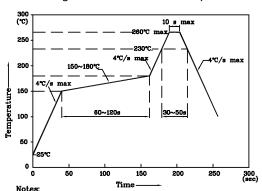






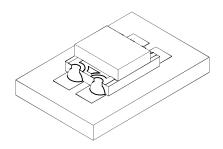
# LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

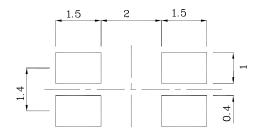


- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

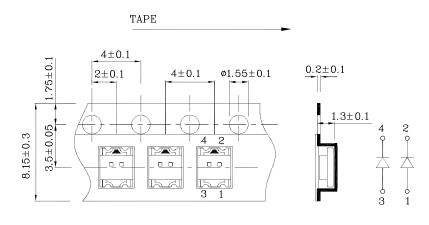
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



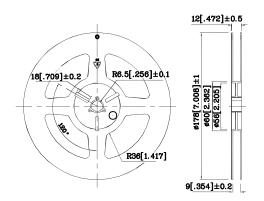
## **♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### **❖** Tape Specification (Units:mm)



### **❖** Reel Dimension



#### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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### PACKING & LABEL SPECIFICATIONS

